**FAIRCHILE** 

# P-Channel 2.5V PowerTrench<sup>®</sup> MOSFET

# **General Description**

This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

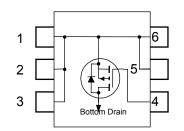
SuperSOT-6<sup>™</sup> FLMP

# Applications

- Battery management
- Load Switch
- Battery protection

# Features

- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- Fast switching speed
- FLMP SuperSOT-6 package: Enhanced thermal performance in industry-standard package size



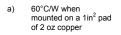
# Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage			-20	V
V <sub>GSS</sub>	Gate-Source	e Voltage		±12	V
I <sub>D</sub>	Drain Curre	nt – Continuous	(Note 1a)	-7	A
		– Pulsed		-40	
P <sub>D</sub>	Power Dissi	pation	(Note 1a)	2	W
			(Note 1b)	1.5	
T <sub>J</sub> , T <sub>STG</sub>	Operating a	nd Storage Junction Tempe	–55 to +150		
	Thermal Res	<b>eristics</b> sistance, Junction-to-Ambie	nt (Note 1a)	60	°C/W
	1		nt (Note 1a) (Note 1b)	60 111	°C/W
$R_{\theta JA}$	Thermal Res				°C/W
$R_{\theta JA}$ $R_{\theta JC}$	Thermal Res	sistance, Junction-to-Ambie	(Note 1b)	111	°C/W
R <sub>0JA</sub> R <sub>0JC</sub> Packag	Thermal Res	sistance, Junction-to-Ambie sistance, Junction-to-Case	(Note 1b)	111	C/W

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Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = -250 \mu A$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to 25°C		-12		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$ , $V_{GS} = 0 V$			-1	μA
I <sub>GSS</sub>	Gate–Body Leakage	$V_{GS}$ = ±12 V, $V_{DS}$ = 0 V			±100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-0.6	-0.9	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = – 250 µA, Referenced to 25°C		3		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{\rm GS} = -4.5 \ V,  I_{\rm D} = -7 \ A \\ V_{\rm GS} = -2.5 \ V, \ I_{\rm D} = -6 \ A \\ V_{\rm GS} = -4.5 \ V, \ I_{\rm D} = -7 \ A, \ T_{\rm J} = 125^{\circ} C \end{array} $		14 21 17	22 30 31	mΩ
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5 V$ , $I_{D} = -7 A$		30		S
Dvnamio	Characteristics				•	
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 V$ , $V_{GS} = 0 V$ ,		2640	1	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		560		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			280		pF
R <sub>G</sub>	Gate Resistance	$V_{GS}$ = 15 mV, f = 1.0 MHz		3.6		Ω
Switchir	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -10 V$ , $I_D = -1 A$ ,		16	28	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		11	19	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			75	120	ns
t <sub>f</sub>	Turn–Off Fall Time			41	65	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$ , $I_D = -7 A$ ,		27	38	nC
Q <sub>gs</sub>	Gate–Source Charge	$V_{GS} = -5 V$		5		nC
$Q_{gd}$	Gate-Drain Charge			7		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source	e Diode Forward Current			-1.6	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_S = -1.6 A$ (Note 2)		-0.7	-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$I_{\rm F} = -7  {\rm A},$		28		ns
Q <sub>rr</sub>	Reverse Recovery Charge	d <sub>iF</sub> /d <sub>t</sub> = 100 A/µs		14	1	nC

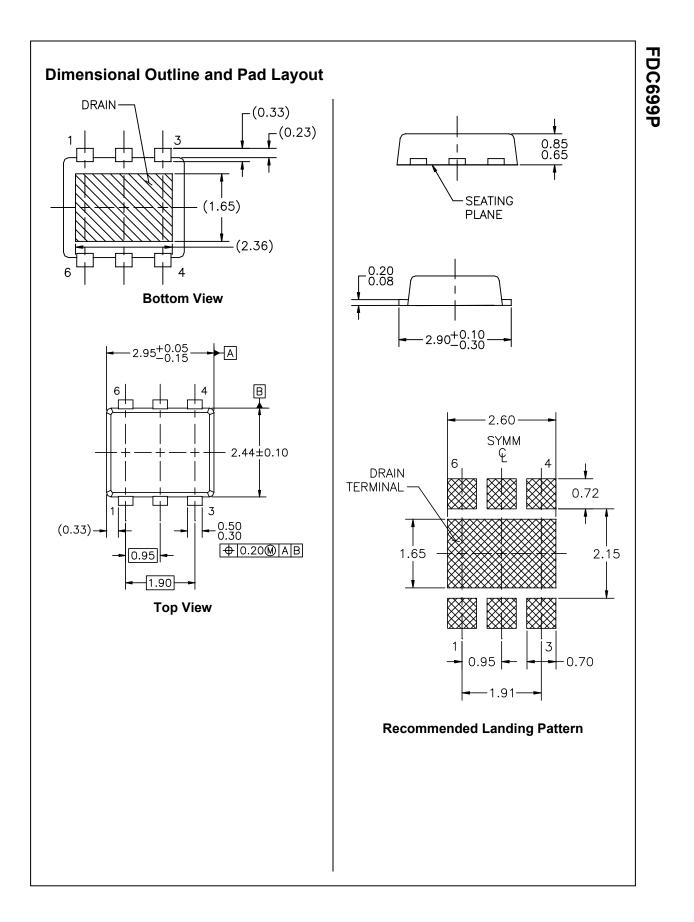


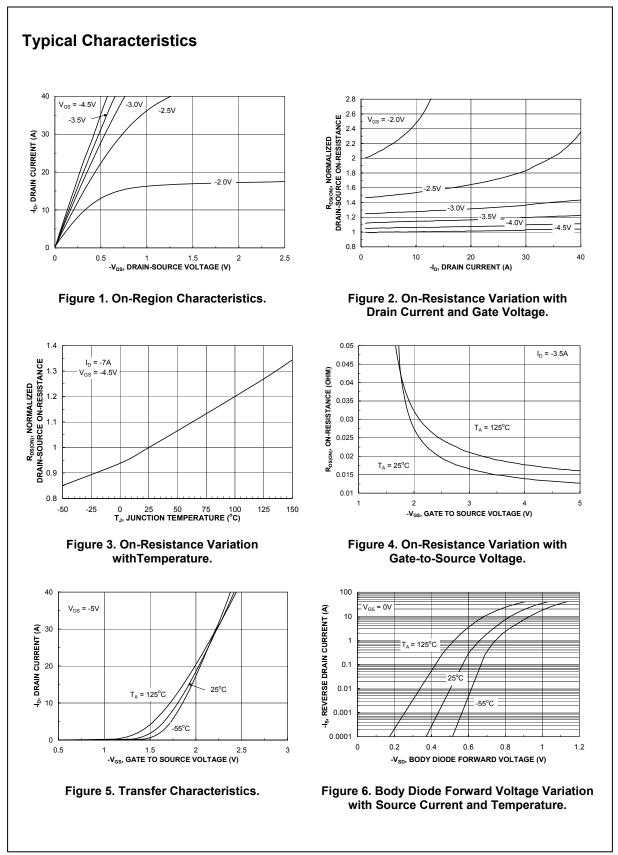


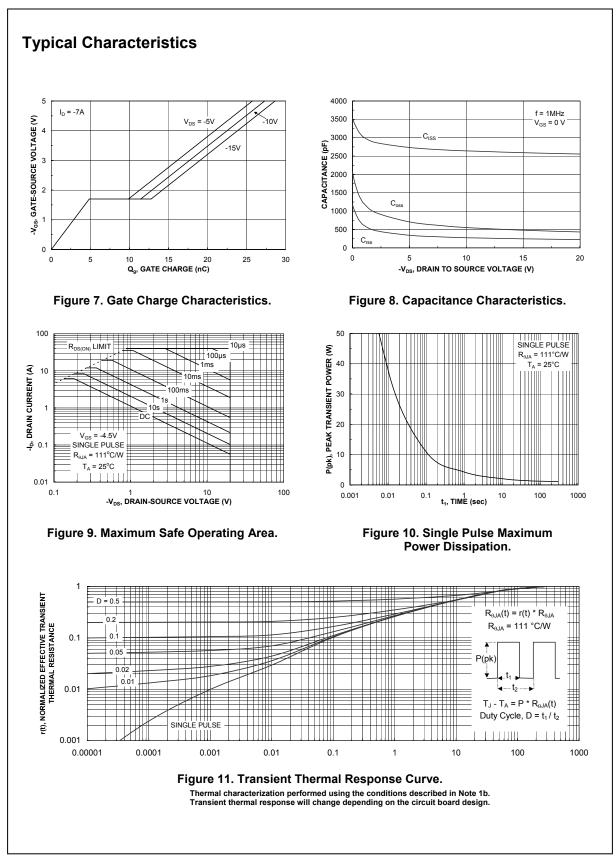


b) 111°C/W when mounted on a minimum pad of 2 oz copper

Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%







FDC699P Rev C2 (W)

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#### **PRODUCT STATUS DEFINITIONS**

**Definition of Terms** 

Product Status	Definition
Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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# FDC699P

P-Channel 2.5V Power Mosfet MOSFET Recommend FDC699P\_F077

#### Contents

•<u>General description</u> •<u>Features</u> •<u>Applications</u> •Product status/pricing/packaging

•<u>Order Samples</u> •<u>Models</u> •Qualification Support

# General description

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## back to top

# Features

- -7 A, -20V R<sub>DS(ON)</sub> = 22 mOhm @ VGS = -4.5 V R<sub>DS(ON)</sub> = 30 mOhm @ VGS = -2.5 V
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- Fast switching speed
- FLMP SuperSOT-6 package: Enhanced thermal performance in industry-standard package size

## back to top

## Applications

- Battery management
- Load Switch
- Battery protection

# **Related Links**

Request samples

- How to order products
- Product Change Notices (PCNs)

<u>Support</u>

- Sales support
- **A 1 1 1 1 1 1**

Quality and reliability

Design center

This page Print version

This product Use in FETBench







## back to top

Product status/pricing/packaging

BUY

Product	Product status	Pb-free Status	Pricing*	Package type	Leads	Packing method	Package Marking Convention**
FDC699P	Not recommended for new designs	Ø	\$0.45	SSOT-6 FLMP	6	TAPE REEL	Line 1: &E& <b>Y</b> (Binary Calendar Year Coding) Line 2: .699
FDC699P_F077	Full Production	Full Production	\$0.57	SSOT-6 FLMP	6	TAPE REEL	Line 1: &E& <b>Y</b> (Binary Calendar Year Coding) Line 2: .699

\* Fairchild 1,000 piece Budgetary Pricing
 \*\* A sample button will appear if the part is available through Fairchild's on-line samples program. If there is no sample button, please contact a <u>Fairchild distributor</u> to obtain samples

Ø Indicates product with Pb-free second-level interconnect. For more information click here.

Package marking information for product FDC699P is available. Click here for more information .

# back to top

#### Models

Package & leads	Condition	n Temperature range Software version Revis		Revision date
		PSPICE		
SSOT-6 FLMP-6	<u>Electrical</u>	25°C to 125°C	Orcad 9.1	Jan 6, 2004

#### back to top

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Click on a product for detailed qualification data

Product			
FDC699P			
FDC699P_F077			

back to top



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